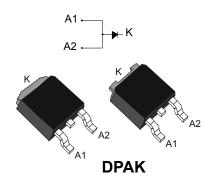


2 x 7.5 A - 45 V low drop power Schottky rectifier



Features

- · Very small conduction losses
- Negligible switching losses
- · Extremely fast switching
- Low forward voltage drop
- Low capacitance
- Avalanche capability specified
- ECOPACK2 compliant component

Applications

- SMPS
- · Freewheeling diodes
- · Switching diodes

Description

Dual center tab Schottky rectifier suited for SMPS and high frequency DC to DC converters.

Packaged in DPAK, the STPS15L45C is intended for use in low voltage, high frequency inverters, freewheeling and polarity protection applications.

Product status link
STPS15L45C

Product summary			
Symbol	Value		
I _{F(AV)}	2 x 7.5 A		
V _{RRM}	45 V		
T _{j(max.)}	150 °C		
V _{F(typ.)}	0.40 V		



1 Characteristics

Table 1. Absolute ratings (limiting values, per diode, at 25 °C unless otherwise specified)

Symbol	Parameter				Unit
V_{RRM}	Repetitive peak reverse voltage			45	V
I _{F(RMS)}	Forward rms current			10	Α
I=		$T_c = 140 ^{\circ}\text{C}$, $\delta = 0.5 ^{\circ}\text{square wave}$	Per diode	7.5	_
I _{F(AV)} Average forward current	1 _C = 140 C, 0 = 0.5 Square wave	Per device	15	Α	
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$			75	Α
P _{ARM}	Repetitive peak avalanche power t_p = 10 μ s, T_j = 125 $^{\circ}$ C			265	W
T _{stg}	Storage temperature range			-65 to +175	°C
Tj	Maximum operating junction temperature ⁽¹⁾			150	°C

^{1.} $(dP_{tot}/dT_i) < (1/R_{th(i-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameters

Symbol	Parameter		Max. value	Unit
Pu a	Duran lunction to cope	Per diode	4	
R _{th(j-c)} Junction to case	Total	2.4	°C/W	
R _{th(c)}	Coupling		0.7	

When the diodes 1 and 2 are used simultaneously:

 $\Delta \ T_j(diode\ 1) = P(diode\ 1)\ x\ R_{th(j-c)}(per\ diode) + P(diode\ 2)\ x\ R_{th(c)}$

For more information, please refer to the following application note:

AN5088: Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Poverse leekage ourrent	T _j = 25 °C	V _R = V _{RRM}	-		500	μA
'R`	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C	VR - VRRM	-	60	120	mA
	V _F ⁽²⁾ Forward voltage drop	T _j = 25 °C	I _F = 7.5 A	-		0.52	
		T _j = 125 °C		-	0.40	0.46	
V_(2)		T _j = 25 °C	I _F = 12 A	-		0.60	V
VF` /		T _j = 125 °C		-	0.49	0.57	V
		T _j = 25 °C	I _F = 15 A	-		0.64	
		T _j = 125 °C	IF - 13 A	-	0.53	0.63	

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses, use the following equation:

DS2653 - Rev 5 page 2/10

^{2.} Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$



$$P = 0.29 \times I_{F(AV)} + 0.023 \times I_{F^{2}(RMS)}$$

For more information, please refer to the following application notes related to the power losses :

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

DS2653 - Rev 5 page 3/10



1.1 Characteristics (curves)

Figure 1. Average forward power dissipation versus average forward current (per diode)

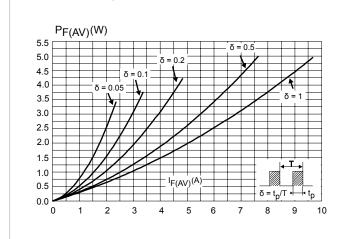


Figure 2. Average forward current versus ambient temperature (δ = 0.5, per diode)

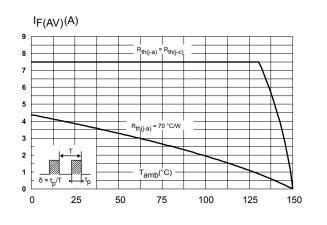


Figure 3. Normalized avalanche power derating versus pulse duration ($T_i = 125 \, ^{\circ}\text{C}$)

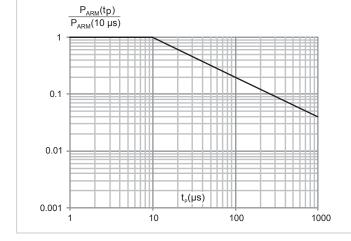
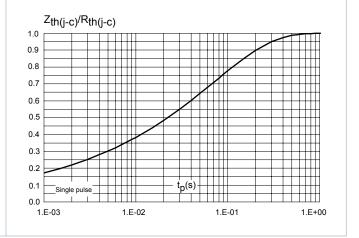


Figure 4. Relative variation of thermal impedance junction to case versus pulse duration



DS2653 - Rev 5 page 4/10



Figure 5. Reverse leakage current versus reverse voltage applied (typical values, per diode)

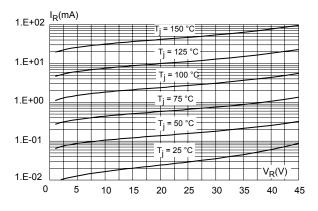


Figure 6. Junction capacitance versus reverse voltage applied (typical values, per diode)

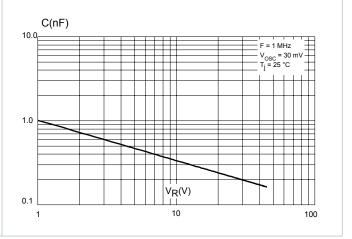


Figure 7. Forward voltage drop versus forward current (per diode)

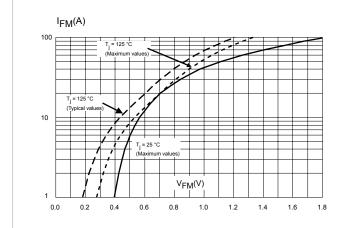
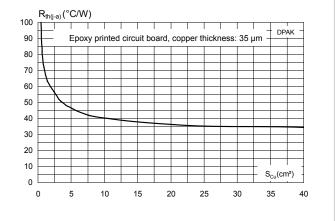


Figure 8. Thermal resistance junction to ambient versus copper surface under tab



DS2653 - Rev 5 page 5/10



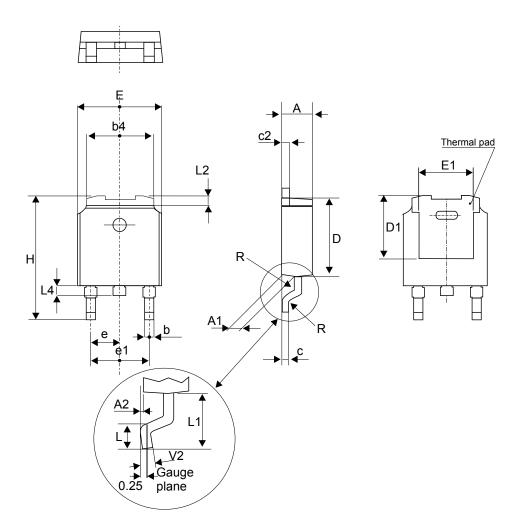
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 DPAK package information

- Epoxy meets UL 94,V0
- Cooling method: by conduction (C)

Figure 9. DPAK package outline



Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

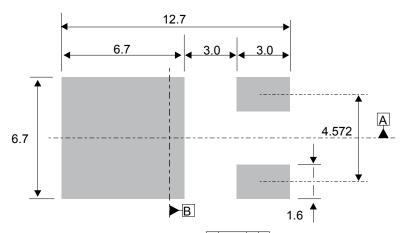
DS2653 - Rev 5 page 6/10



Table 4. DPAK package mechanical data

	Dimensions				
Ref.	Millin	neters	Inches (for reference only)		
	Min.	Max.	Min.	Max.	
Α	2.18	2.40	0.085	0.094	
A1	0.90	1.10	0.035	0.043	
A2	0.03	0.23	0.001	0.009	
b	0.64	0.90	0.025	0.035	
b4	4.95	5.46	0.194	0.215	
С	0.46	0.61	0.018	0.024	
c2	0.46	0.60	0.018	0.023	
D	5.97	6.22	0.235	0.244	
D1	4.95	5.60	0.194	0.220	
E	6.35	6.73	0.250	0.265	
E1	4.32	5.50	0.170	0.216	
е	2.28	6 typ.	0.09	0 typ.	
e1	4.40	4.70	0.173	0.185	
Н	9.35	10.40	0.368	0.409	
L	1.0	1.78	0.039	0.070	
L2		1.27		0.050	
L4	0.60	1.02	0.023	0.040	
V2	-8°	+8°	-8°	+8°	

Figure 10. DPAK recommended footprint (dimensions in mm)



The device must be positioned within ⊕0.05 AB

DS2653 - Rev 5 page 7/10



3 Ordering Information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS15L45CB	S15L45C	DPAK	0.35 g	75	Tube
STPS15L45CB-TR	3131430	DFAN		2500	Tape and reel

DS2653 - Rev 5 page 8/10



Revision history

Table 6. Document revision history

Date	Version	Changes
10-Mar-2011	2	Automatic revalidation date workflow started.
07-Jul-2015	3	Updated DPAK package information and reformatted to current standard. Removed IPAK.
29-Nov-2018	4	Updated DPAK package information and reformatted to current standard.
09-Aug-2019	5	Added Section Applications. Updated Table 3, Figure 4 and Table 5.

DS2653 - Rev 5 page 9/10



IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, please refer to www.st.com/trademarks. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2019 STMicroelectronics - All rights reserved

DS2653 - Rev 5 page 10/10

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

STMicroelectronics:

STPS15L45CB-TR STPS15L45CB